

# DIGITRON SEMICONDUCTORS

## MAC219 SERIES

## SILICON BIDIRECTIONAL THYRISTORS

Available Non-RoHS (standard) or RoHS compliant (add PBF suffix).

Available as "HR" (high reliability) screened per MIL-PRF-19500, JANTX level. Add "HR" suffix to base part number.

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
<b>Peak repetitive off-state voltage</b> <sup>(1)</sup> (T <sub>J</sub> = -40 to +125°C) MAC219-4 MAC219-6 MAC219-8 MAC219-10	V <sub>DRM</sub>	200 400 600 800	Volts
<b>Peak gate voltage</b>	V <sub>GM</sub>	±10	Volts
<b>RMS on-state current</b> (conduction angle = 360°, T <sub>C</sub> = 80°C)	I <sub>T(RMS)</sub>	8.0	Amps
<b>Peak non-repetitive surge current</b> (1 cycle, 60 Hz)	I <sub>TSM</sub>	100	Amps
<b>Circuit fusing considerations</b> (t = 8.3ms)	I <sup>2</sup> t	35	A <sup>2</sup> s
<b>Peak gate power</b> (T <sub>C</sub> = 80°C, pulse width = 2µs)	P <sub>GM</sub>	16	Watts
<b>Average gate power</b> (T <sub>C</sub> = 80°C, t = 8.3ms)	P <sub>G(AV)</sub>	0.35	Watts
<b>Peak gate trigger current</b> (Pulse width = 1.0µs)	I <sub>GM</sub>	4.0	Amps
<b>Operating junction temperature range</b>	T <sub>J</sub>	-40 to +125	°C
<b>Storage temperature range</b>	T <sub>stg</sub>	-40 to +150	°C

Note 1: Ratings apply for open gate conditions. Thyristor devices shall not be tested with a constant current source for blocking capability such that the voltage applied exceeds the rated blocking voltage.

### THERMAL CHARACTERISTICS

Characteristic	Symbol	Maximum	Unit
<b>Thermal resistance, junction to case</b>	R <sub>θJC</sub>	2.2	°C/W

### ELECTRICAL CHARACTERISTICS (T<sub>C</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Typ.	Max	Unit
<b>Peak blocking current</b> (either direction) (V <sub>D</sub> = Rated V <sub>DRM</sub> @ T <sub>J</sub> = 25°C) (V <sub>D</sub> = Rated V <sub>DRM</sub> @ T <sub>J</sub> = 125°C)	I <sub>DRM</sub>	-	-	10 2	µA mA
<b>Peak on-state voltage</b> (either direction) (I <sub>TM</sub> = 11.3A peak, pulse width = 1 to 2 ms, duty cycle ≤ 2%)	V <sub>TM</sub>	-	1.7	2.0	Volts
<b>Gate trigger current</b> (continuous dc) (main terminal voltage = 12V, R <sub>L</sub> = 12Ω) Trigger mode MT2(+),G(+); MT2(+),G(-); MT2(-),G(-)	I <sub>GT</sub>	-	-	100	mA
<b>Gate trigger voltage</b> (continuous dc) (main terminal voltage = 12V, R <sub>L</sub> = 100Ω) MT2(+),G(+) MT2(+),G(-) MT2(-),G(-) (main terminal voltage = Rated V <sub>DRM</sub> , R <sub>L</sub> = 10kΩ, T <sub>J</sub> = 125°C) MT2(+), G(+); MT2(-), G(-); MT2(+), G(-)	V <sub>GT</sub>	-	0.9 0.9 1.1	2 2 2	Volts
		0.2	-	-	

# DIGITRON SEMICONDUCTORS

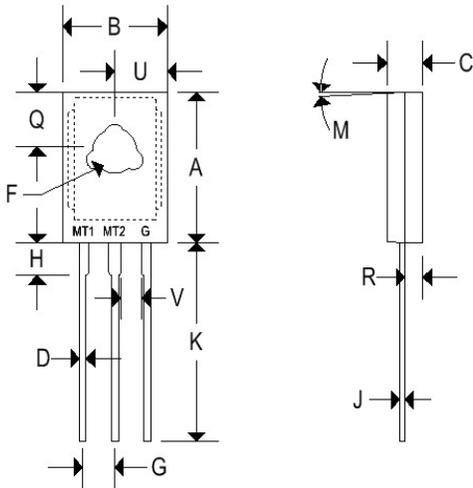
MAC219 SERIES

SILICON BIDIRECTIONAL THYRISTORS

Characteristic	Symbol	Min	Typ.	Max	Unit
<b>Holding current</b> (either direction) (main terminal voltage= 12V, gate open, initiating current = 200mA)	$I_H$	-	-	100	mA
<b>Rate of rise of commutation voltage</b> (Rated $V_{DRM}$ , $I_{T(RMS)} = 6.0A$ , commutating $di/dt = 4.3A/ms$ , gate unenergized, $T_c = 80^\circ C$ )	$dv/dt(c)$	-	5.0	-	V/ $\mu s$
<b>Critical rate of rise of off-state voltage</b> ( $V_D = \text{Rated } V_{DRM}$ , exponential voltage rise, gate open, $T_c = 25^\circ C$ ) ( $V_D = \text{Rated } V_{DRM}$ , exponential voltage rise, gate open, $T_c = 125^\circ C$ )	$dv/dt$	500 200	- -	- -	V/ $\mu s$

## MECHANICAL CHARACTERISTIC

<b>Case</b>	TO-220AB
<b>Marking</b>	Body painted, alpha-numeric
<b>Pin out</b>	See below



	TO-220AB			
	Inches		Millimeters	
	Min	Max	Min	Max
A	0.575	0.620	14.600	15.750
B	0.380	0.405	9.650	10.290
C	0.160	0.190	4.060	4.820
D	0.025	0.035	0.640	0.890
F	0.142	0.147	3.610	3.730
G	0.095	0.105	2.410	2.670
H	0.110	0.155	2.790	3.930
J	0.014	0.022	0.360	0.560
K	0.500	0.562	12.700	14.270
L	0.045	0.055	1.140	1.390
N	0.190	0.210	4.830	5.330
Q	0.100	0.120	2.540	3.040
R	0.080	0.110	2.040	2.790
S	0.045	0.055	1.140	1.390
T	0.235	0.255	5.970	6.480
U	-	0.050	-	1.270
V	0.045	-	1.140	-
Z	-	0.080	-	2.030

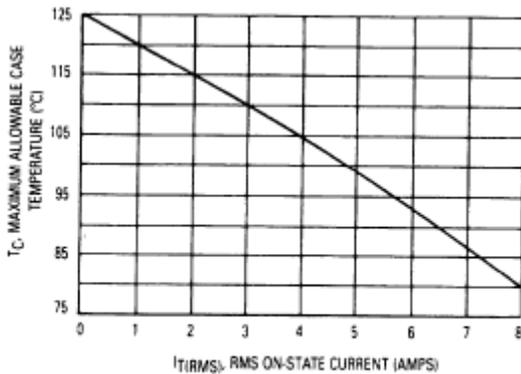


Figure 1. Current Derating

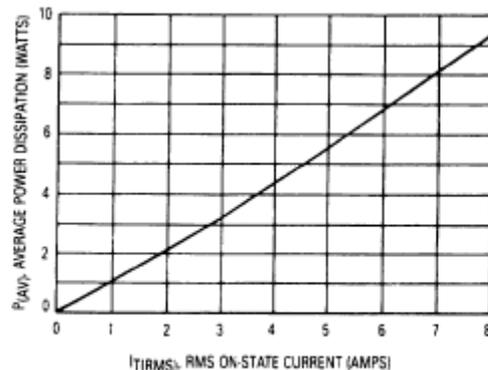


Figure 2. Power Dissipation